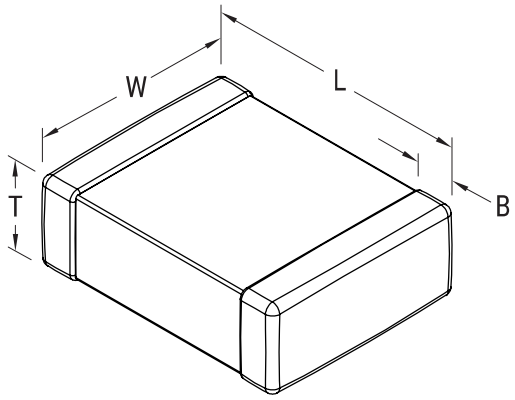
KEMET Part Number: CDR01BX821BKSP

(C0805P821K1XPH, C0805P821K1XPH-MILITARYBULK)

SMD Mil PRF55681, Ceramic, Military/High Reliability, 820 pF, 10%, 100 VDC, BX, P (0.1%/1000 Hrs), 0805



Dimensions	
L	2.03mm +0.89/-0.38mm (0.08 in +0.035/-0.015 in)
W	1.27mm +0.76/-0.38mm (0.05 in +0.03/-0.015 in)
T	0.98mm +0.8/-0.42mm (0.039 in +0.031/-0.017 in)
B	0.51mm +0.63/-0.25mm (0.02 in +0.025/-0.01 in)

Packaging Specifications	
Packaging:	Bulk, Bag
Packaging Quantity:	1

General Information	
Supplier:	KEMET
Series:	SMD Mil PRF55681
Style:	SMD Chip
RoHS:	No
Prop 65:	**WARNING:** Cancer and reproductive harm - www.p65warnings.ca.gov.
REACH:	SVHC (Pb – CAS 7439-92-1)
Termination:	Lead (SnPb)
Failure Rate:	P (0.1%/1000 Hrs)
Testing and Reliability:	MIL-PRF-55681
Qualifications:	MIL-PRF-55681
Miscellaneous:	Termination Description: SolderCoat 60-40
Chip Size:	0805

Specifications	
Capacitance:	820 pF
Capacitance Tolerance:	10%
Voltage DC:	100 VDC
Temperature Range:	-55/+125C
Temperature Coefficient:	BX

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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